





(Toll Free no.: 1800 1200 106 Mobile: 8588811998, 9911150880)

## **Internal Undertaking for Patent/Copyright/Trademark**

I/We ANMOL JAIN (CS)

Main Applicant: KIET GROUP OF INSTITUTIONS DELHI - NCR

Co-applicant / INVENTOR: ANMOL JAIN (CS) MOHD DANISH KHAN (2125CS1083) MOHD MOHSIN ANSARI (2125CS1111) NAVNEET KUMAR RAO (2125CS1194) RAHUL KUMAR GAUTAM (2125CS1173)

I/We have in the course of my study/ employment invented titled, **Ecommerce Platform for Bakers** by using the facilities of Institute and I/We are the true and first inventor.

I/We hereby abide by the IPR Policy which was approved by the management and now public to all stakeholders. Also, the intent of research policy of KIET is towards promoting and encouraging Students/Faculties for recognition of their work by promoting their invention through filing patent/copyright/trademark.

I/We are opting the OPTION - 1

I/We would like to engage with the institute for filing the patent/design/copyright/trademark as per IPR policy. I/We do not have any objection by giving unconditional rights to college (KIET Group of Institutions) to file and register the patent/design/copyright/trademark in their name.

I/We hereby state that we shall be abide by the IPR policy clause no. **8.2**, **8.3**, **9**, **9.1**, **9.2**, **10**, **10.1**, **a**, **b**, **c** and **10.2** approved by college management.

I/We do not have any objection by giving unconditional rights to college (KIET Group of Institutions) to file and register the patent/design/copyright/trademark in their name. My/Our claims shall be as per the defined ratio in clause no. 10, 10.1, a, b, c and 10.2 of IPR for sharing revenue if generated through commercialization either by transferring technology fee/ royalty/ onetime fee or establishing the venture in future. Both parties shall keep update to each other as per clause and shall abide by the policy.

I/We have given this undertaking at my/our own will and without having any kind of compulsion and pressure by and on behalf of the Institute.

Signature of the Co- Applicant/Inventor(s)	Recommendation of HoD
	HOD
	Signature